

2A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

- · Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	2	Α	
V_{RRM}	200 - 1000	V	
I _{FSM}	50 A		
$T_{J MAX}$	150 °C		
Package	Thin SMA		
Configuration	Single die		





Thin SMA



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	S2D	S2G	S2J	S2K	S2M	UNIT
FARAMETER	31 MBOL	ALH	ALH	ALH	ALH	ALH	
Marking code on the device		S2DAH	S2GAH	S2JAH	S2KAH	S2MAH	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	٧
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	560	700	٧
Forward current	I _F			2			Α
Surge peak forward current, t = 8.3ms				50			Α
single half sine-wave superimposed on rated load t = 1.0ms	- I _{FSM}			140			Α
Junction temperature	T _J	-55 to +150		°C			
Storage temperature	T _{STG}	-55 to +150		°C			

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	14	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	74	°C/W	
Junction-to-case thermal resistance	R _{eJC}	20	°C/W	

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1A, T_J = 25^{\circ}C$		0.91	-	V
	$I_F = 2A, T_J = 25^{\circ}C$	V _F	0.98	1.10	V
	I _F = 1A, T _J = 125°C		0.79	-	V
	I _F = 2A, T _J = 125°C		0.88	0.98	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	- I _R	-	1	μΑ
	T _J = 125°C		-	33	μΑ
Junction capacitance	1MHz, V _R = 4.0V	CJ	12	-	рF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
S2xALH	Thin SMA	14,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 200V(S2DALH) to 1000V(S2MALH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

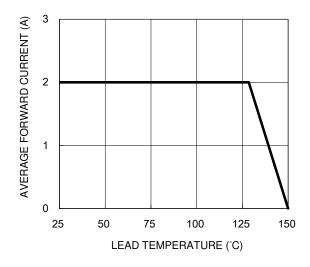
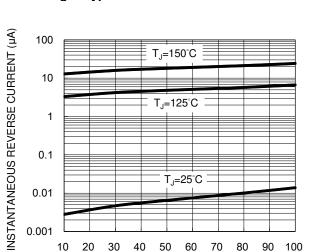


Fig.3 Typical Reverse Characteristics



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

Fig.2 Typical Junction Capacitance

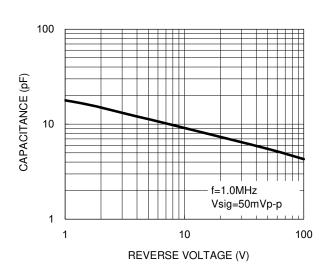


Fig.4 Typical Forward Characteristics

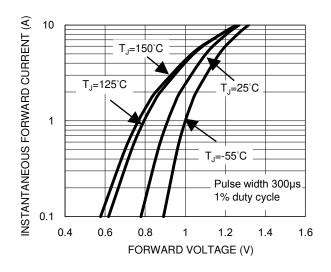
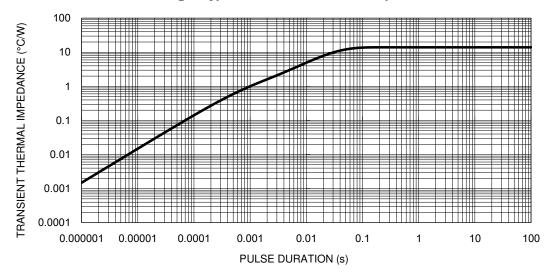


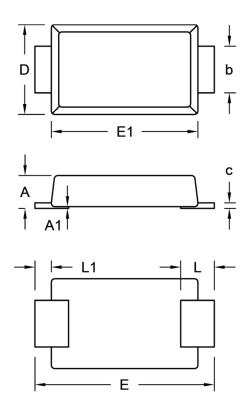
Fig.5 Typical Transient Thermal Impedance





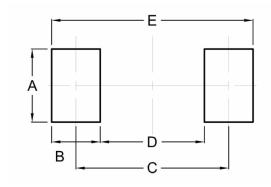
PACKAGE OUTLINE DIMENSIONS

Thin SMA



DIM.	Unit (mm) Min. Max.		Unit ((inch)	
DIIVI.			Min.	Max.	
Α	0.90	1.00	0.035	0.039	
A1	0.00	0.10	0.000	0.004	
b	1.25	1.45	0.049	0.057	
С	0.10	0.22	0.004	0.009	
D	2.50	2.70	0.098	0.106	
E	5.05	5.35	0.199	0.211	
E1	4.15	4.35	0.163	0.171	
L	0.75	1.20	0.030	0.047	
L1	0.30	0.60	0.012	0.024	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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